



GNSS Ceramic Chip Antenna Model: AA088 TELA Series Product Number: H2U14W1H1A0400

REFERENCE SPECIFICATION

Unique Electronics You Need

Downloaded from Arrow.com.

Version: 10702A_rev-G



Notes

Packing

Tuning

Table of Contents

1	Intr	oduction	3
2	Elec	trical Characteristics	4
	2.1	Table with electrical properties:	4
	2.2	Return Loss (S ₁₁)	5
	2.3	VSWR (S ₁₁)	5
	2.5	Efficiency Table	6
	2.6	Efficiency vs. Frequency	7
	2.7	Radiation Pattern (with 80x40mm ² Evaluation Board)	8
3	Lay	out	2
	3.1	Antenna Dimensions	2
	3.2	Evaluation Board with Antenna13	3
	3.3	Solder Land Pattern (unit: mm)14	4
4	Free	quency tuning1!	5
	4.1	Reference for frequency tuning element10	6
5	Pac	king1	7
	5.1	Packing Process	0
6	Not	es2:	1
	6.1	Typical Soldering Profile for Lead-free Process	1
	6.2	Operating and storage conditions: 22	2
	6.3	Installation guide:	2
	6.4	Reminders for users of Unictron's AA088 ceramic chip antennas	2



1 Introduction

Unictron's AA088 ceramic chip antenna is designed for GNSS band applications, covering frequencies 1560~1606 MHz. Fabricated with proprietary design and processes, AA088 shows excellent performance and is fully compatible with SMT processes which can decrease the assembly cost and improve device's quality and consistency.

Features

*Stable and reliable in performances

*Low profile, compact size

*RoHS compliance

*SMT processes compatible

Applications

*GNSS (Global Navigation Satellite System)

*Hand-held devices when GPS & BDS & GLONASS & GALILEO functions are needed, e.g., PDA, Smart phone, PND.



Tuning Packing Notes

2 Electrical Characteristics

2.1 Table with electrical properties:

Char	acteristics	Specifications	Unit
Outline Dimensi	ons	3.2x1.6x0.5	mm
Ground Plane Di	mensions	80x40	mm
Working Freque	ncy	1560~1606	MHz
VSWR (@Center F	requency)*	2 Max. (typical)	
Characteristic Im	npedance	50	Ω
Polarization		Linear Polarization	
Peak Gain		3.3 (typical)	dBi
Efficiency	(@1575.42IVIHZ)	83 (typical)	%

** Center frequency will be offset to another frequency according to the conditions of user's ground plane and radome.



Radiation Pattern | Layout

Tuning Packing

ng Notes

2.2 Return Loss (S₁₁)



2.3 VSWR (S₁₁)





Introduction

Electrical Characteristics

Radiation Pattern Layout Tuning

Packing Notes

2.5 Efficiency Table

Frequency(MHz)	1560	1561	1562	1563	1564	1565	1566	1567	1568	1569	1570
Efficiency(dB)	-1.7	-1.3	-1.2	-1.1	-1.0	-1.0	-0.9	-0.9	-0.9	-0.9	-0.8
Efficiency(%)	67.9	74.3	76.2	77.6	79.1	80.0	80.6	81.1	81.7	82.2	83.4
Gain(dBi)	2.8	2.9	3.0	3.1	3.1	3.1	3.2	3.2	3.2	3.2	3.3

Frequency(MHz)	1571	1572	1573	1574	1575	1576	1577	1578	1579	1580	1581
Efficiency(dB)	-0.8	-0.8	-0.8	-0.8	-0.8	-0.8	-0.8	-0.8	-0.8	-0.8	-0.8
Efficiency(%)	83.8	84.0	83.6	83.4	83.4	83.6	84.0	84.0	84.2	83.8	82.4
Gain(dBi)	3.3	3.3	3.3	3.3	3.3	3.3	3.3	3.3	3.3	3.3	3.2

Frequency(MHz)	1582	1583	1584	1585	1586	1587	1588	1589	1590	1591	1592
Efficiency(dB)	-0.8	-0.9	-0.9	-0.9	-0.9	-0.9	-0.9	-1.0	-1.1	-1.0	-1.0
Efficiency(%)	82.4	82.2	82.2	81.9	81.5	80.7	80.6	79.8	78.5	78.7	78.7
Gain(dBi)	3.2	3.1	3.1	3.1	3.1	3.1	3.0	3.0	2.9	2.9	2.9

Frequency(MHz)	1593	1594	1595	1596	1597	1598	1599	1600	1601	1602	1603
Efficiency(dB)	-1.0	-1.1	-1.1	-1.2	-1.2	-1.2	-1.2	-1.2	-1.3	-1.7	-1.5
Efficiency(%)	78.7	78.2	77.6	76.4	76.1	75.7	75.7	75.2	74.1	72.0	71.6
Gain(dBi)	2.9	2.9	2.8	2.8	2.8	2.8	2.7	2.7	2.7	2.6	2.5

Frequency(MHz)	1604	1605	1606
Efficiency(dB)	-1.5	-1.6	-1.7
Efficiency(%)	70.2	69.2	68.1
Gain(dBi)	2.5	2.4	2.4



Radiation Pattern Layout

Tuning Packing

2.6 Efficiency vs. Frequency





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Tuning Packing

Packing Notes

2.7 Radiation Pattern (with 80x40mm² Evaluation Board)

3D Gain Pattern @ 1561 MHz (unit: dBi)











Radiation Pattern L

Layout Tuning Packir

Packing Notes

3D Gain Pattern @ 1575.42 MHz (unit: dBi)





Electrical Characteristics Introduction

Radiation Pattern

Tuning Layout

Packing Notes

3D Gain Pattern @ 1590 MHz (unit: dBi)







Radiation Pattern La

ern Layout Tun

Tuning Packi

Packing Notes

3D Gain Pattern @ 1602 MHz (unit: dBi)







Introduction

Layout

3 Layout

3.1 Antenna Dimensions





Radiation Pattern Layout

Tuning Packing

Notes

3.2 Evaluation Board with Antenna





Tuning Packing Notes

3.3 Solder Land Pattern (unit: mm)

The solder land pattern (gold marking areas) is shown below. Recommendation on matching circuit will be provided according to customer's installation conditions.



Transmission line with 50 Ohm impedance characteristics.



BOTTOM VIEW



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4 Frequency tuning

Chip antenna tuning scenario



With the following recommended values of matching and tuning components, the Center frequency will be about 1575.42 MHz at our standard 80 x 40 mm² evaluation board. However, these are typical reference values which may need to be changed when circuit boards or part vendors are different.

	System Match	ing Circuit Comp	onent	
	Location	Description	Vendor	Tolerance
	1	1.5 pF,(0402)	Murata	±0.05pF
	2	0Ω		
	3	3.3 pF,(0402)	Murata	±0.05pF
	4	1 pF, (0402)	Murata	±0.05pF
<u> </u>	Fine tuning			
	element			
	5	2.7 pF, (0402)	Murata	±0.05pF
	Fine tuning			
	element			



Notes

Packing

Tuning

4.1 Reference for frequency tuning element





Packing

Layout Tuning

Radiation Pattern

Notes

5 Packing

- 1. Quantity/Reel: 5000 pcs/Reel
- 2. Plastic tape:

 $\xrightarrow{P_{O}} \xrightarrow{P_{C}} \xrightarrow{P_{C}} \xrightarrow{B} \xrightarrow{B} \xrightarrow{B} \xrightarrow{P_{O}} \xrightarrow{B} \xrightarrow{P_{O}} \xrightarrow{B} \xrightarrow{P_{O}} \xrightarrow{B} \xrightarrow{P_{O}} \xrightarrow{P_{O$

a) Tape drawing:

b) Tape dimensions (unit: mm)

Feature	Specifications	Tolerances
W	12.00	±0.30
Р	4.00	±0.10
E	1.75	±0.10
F	5.50	±0.10
P2	2.00	±0.10
D	1.50	+0.10 -0.00
Ро	4.00	±0.10
10Po	40.00	±0.20



c) Reel Drawing



Radiation Pattern Layout

Tuning Packing

Notes

d) Drawing of small size carton in developed view



e) Drawing of middle size carton in developed view





Radiation Pattern Layout

Tuning Packing

Notes

f) Drawing of large size carton in developed view



g) Picture of the label

h) Reel with the label

Unict	ron Technologies Corporation
CUST P/N	
DESC	
P/N	
L/N	
Q"TY	
DATE	



Packing



Introduction | Electrical Characteristics

s Radiation Pattern Layout

Notes

i) Small size carton with the label



j) Middle size carton with the label

Tuning



5.1 Packing Process



1 reel includes max 5000 pieces chip antennas

1 small size carton includes max 2 reels

1 middle size carton includes max 5pcs of small carons

1 large size carton includes max 2 pcs of middle size cartons



Packing

6 Notes

6.1 Typical Soldering Profile for Lead-free Process

Solder paste alloy: SAC305 (Sn96.5/Ag3/Cu0.5) Lead Free solder paste



Time (s)



Radiation Pattern | La

Layout Tuning Packing

Notes

6.2 Operating and storage conditions:

Operating:	Storage:
Maximum Input Power: 2W	Storage Temperature -5C to 40 C
Operating Temperature: -40 C to 85 C	Relative Humidity: 20% to 70%
	Shelf Life: 1 year

6.3 Installation guide:

Request Unictron's application notes "General guidelines for the installation of Unictron's chip antennas" for further information at e-sales@unictron.com.

6.4 Reminders for users of Unictron's AA088 ceramic chip antennas

- 6.4.1. This chip antenna is made of ceramic materials which are relatively more rigid and brittle compared to printed circuit board materials. Bending of circuit board at the locations where chip antenna is mounted may cause the cracking of solder joints or antenna itself.
- 6.4.2. Punching/cutting of the break-off tab of PCB panel may cause severe bending of the circuit board which may result in cracking of solder joints or chip antenna itself. Therefore break-off tab shall be located away from the installation site of chip antenna.
- 6.4.3. Be cautious when ultrasonic welding process needs to be used near the locations where chip antennas are installed. Strong ultrasonic vibration may cause the cracking of chip antenna solder joints.

Packing

Tuning



Introduction | Electrical Characteristics

Radiation Pattern | Layout

Notes

Presented data were measured on reference PCB (ground) as shown in this specification. When the antenna placement or size of the PCB is changed, antenna performance and values of matching components may differ from data shown here.

Information presented in this Reference Specification is believed to be correct as of the date of publishing. Unictron Technologies Corporation reserves the rights to change the Reference Specification without notice due to technical improvements, etc. Please consult with Unictron's engineering team about the latest information before using this product. Per request, we may provide advice and assistance in implementing this antenna to a customer's device by simulation or real measurement of the interested device in our testing facilities.

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